Electronic Patent Application Fee Transmittal							
Application Number:	10613326						
Filing Date:	03-Jul-2003						
Title of Invention:	Vertical conduction flip-chip device with bump contacts on single surface						
First Named Inventor/Applicant Name:	Daniel M. Kinzer						
Filer:	Kourosh Salehi/Jane Lim						
Attorney Docket Number:	IR-2541 DIV						
Filed as Large Entity							
Utility under 35 USC 111(a) Filing Fees							
Description		Fee Code	Quantity	Amount	Sub-Total in USD(\$)		
Basic Filing:							
Pages:							
Claims:							
Miscellaneous-Filing:							
Petition:							
Patent-Appeals-and-Interference:							
Post-Allowance-and-Post-Issuance:							
Extension-of-Time:							
Extension - 1 month with \$0 paid		1251	1	130	130		

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
	Total in USD (\$)			130